

ON Semiconductor®

FDG6332C

20V N & P-Channel PowerTrench[®] MOSFETs

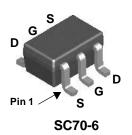
General Description

The N & P-Channel MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive TSSOP-8 and SSOP-6 packages are impractical.

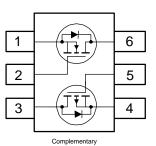
Applications

- DC/DC converter
- Load switch
- LCD display inverter



Features

- Q1 0.7 A, 20V. $R_{DS(ON)} = 300 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 400 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$
- Q2 -0.6 A, -20V. $\begin{array}{c} R_{DS(ON)} = 420 \ m\Omega \ @ \ V_{GS} = -4.5 \ V \\ R_{DS(ON)} = 630 \ m\Omega \ @ \ V_{GS} = -2.5 \ V \end{array}$
- Low gate charge
- High performance trench technology for extremely low R_{DS(ON)}
- SC70-6 package: small footprint (51% smaller than SSOT-6); low profile (1mm thick)



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Q1	Q2	Units	
V _{DSS}	Drain-Sour	Drain-Source Voltage			20 –20		
V _{GSS}	Gate-Source Voltage			±12	±12	V	
ID	Drain Curre	ent – Continuous	(Note 1)	0.7	0.7 –0.6		
		 Pulsed 		2.1	-2		
PD	Power Diss	sipation for Single Oper	ation (Note 1)		W		
T _J , T _{STG}	Operating a	and Storage Junction T	emperature Range	-55	°C		
Therma R _{0JA}		esistance, Junction-to-A	Ambient (Note 1)		415	°C/W	
Packag	e Markin	g and Orderin	g Information				
Device Marking		Device	Reel Size	Tape width		Quantity	
.32		FDG6332C	7"	8mr	3000 units		

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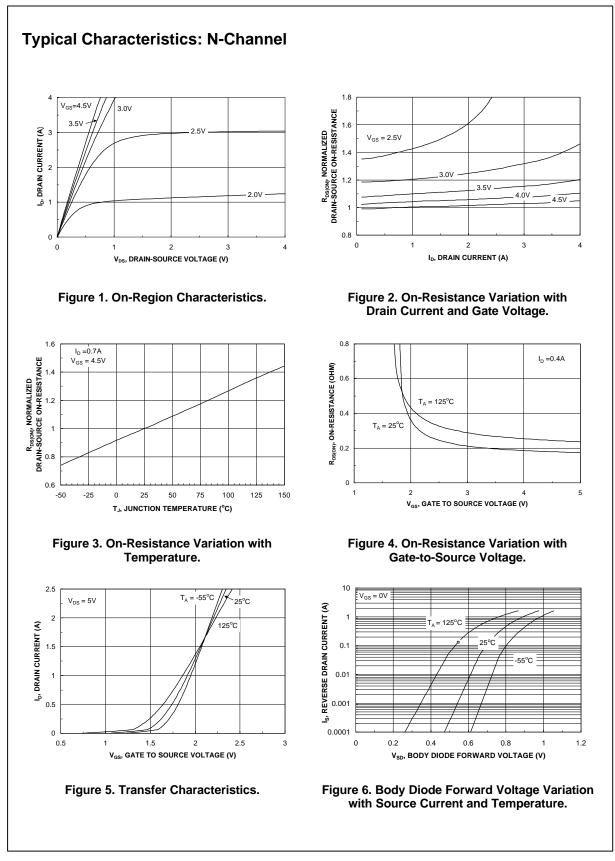
Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted Symbol Min Max Units Parameter **Test Conditions** Тур **Off Characteristics** 20 V $V_{GS} = 0 V$, $I_{D} = 250 \ \mu A$ Q1 **BV**_{DSS} Drain-Source Breakdown Voltage $V_{GS} = 0 V$, $I_{D} = -250 \ \mu A$ Q2 -20 $I_D = 250 \,\mu\text{A},\text{Ref. to } 25^\circ\text{C}$ Breakdown Voltage Temperature ΔBV_{DSS} mV/°C Q1 14 Coefficient $\Delta T_{\rm J}$ $I_D = -250 \ \mu A$, Ref. to $25^{\circ}C$ Q2 -14 $V_{DS} = 16 V$, $V_{GS} = 0 V$ Q1 1 μΑ Zero Gate Voltage Drain Current IDSS $V_{GS} = 0 V$ Q2 $V_{DS} = -16 V$, -1 I_{GSSF} / I_{GSSR} Gate-Body Leakage, Forward $V_{GS}=\pm \ 12 \ V, \quad V_{DS}=0 \ V$ ±100 nA Gate-Body Leakage, Reverse $V_{GS}=\pm~12V~,~~V_{DS}=0~V$ I_{GSSF} /I_{GSSR} ±100 nΑ On Characteristics (Note 2) $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ 0.6 V $V_{GS(th)}$ Gate Threshold Voltage Q1 1.1 1.5 $V_{DS} = V_{GS}, I_D = -250 \ \mu A$ -0.6 -1.2 -1.5 Q2 Gate Threshold Voltage Q1 $I_D = 250 \ \mu\text{A}$, Ref. To 25°C -2.8 mV/°C $\Delta V_{GS(th)}$ **Temperature Coefficient** ΔT_{J} Q2 $I_D = -250 \ \mu$ A,Ref. to 25° C 3 $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.7 \text{ A}$ 180 300 $R_{\text{DS(on)}}$ Static Drain-Source mΩ Q1 $V_{GS} = 2.5 \text{ V}, \quad I_D = 0.6 \text{ A}$ 400 293 **On-Resistance** $V_{GS} = 4.5 \text{ V}, I_D = 0.7 \text{A}, T_J = 125^{\circ}\text{C}$ 442 247 $V_{GS} = -4.5 \text{ V}, I_D = -0.6 \text{ A}$ 300 420 Q2 $V_{GS} = -2.5 \text{ V}, I_D = -0.5 \text{ A}$ 470 630 V_{GS} =-4.5 V, I_D =-0.6 A, T_J =125°C 700 400 $V_{DS} = 5 V$ $I_{D} = 0.7 \text{ A}$ Forward Transconductance 2.8 S Q1 **G**FS $I_{\rm D} = -0.6A$ $V_{DS} = -5 V$ Q2 1.8 On-State Drain Current $V_{GS}=4.5~V, \quad V_{DS}=5~V$ Q1 1 А I_{D(on)} $V_{GS} = -4.5 \ V, \ V_{DS} = -5 \ V$ Q2 -2 **Dynamic Characteristics** \mathbf{C}_{iss} V_{DS}=10 V, V_{GS}= 0 V, f=1.0MHz Input Capacitance Q1 113 pF V_{DS}=-10 V, V_{GS}= 0 V, f=1.0MHz Q2 114 V_{DS}=10 V, V_{GS}= 0 V, f=1.0MHz Coss **Output Capacitance** Q1 34 pF V_{DS}=-10 V, V_{GS}= 0 V, f=1.0MHz Q2 24 V_{DS}=10 V, V_{GS}= 0 V, f=1.0MHz C_{rss} **Reverse Transfer Capacitance** Q1 16 pF V_{DS}=-10 V, V_{GS}= 0 V, f=1.0MHz 9 Q2 Switching Characteristics (Note 2) Turn-On Delay Time 5 10 Q1 t_{d(on)} For **Q1**: ns V_{DS}=10 V, $I_{D} = 1 A$ 5.5 11 Q2 $V_{\text{GS}}\text{=} 4.5 \text{ V}, \quad \text{R}_{\text{GEN}} \text{=} 6 \ \Omega$ 7 15 tr Turn-On Rise Time Q1 ns Q2 For **Q2**: 14 25 V_{DS} =-10 V, I_D= -1 A Turn-Off Delay Time Q1 9 18 ns t_{d(off)} V_{GS} = -4.5 V, R_{GEN} = 6 Ω Q2 6 12 3 Turn-Off Fall Time Q1 1.5 tf ns Q2 1.7 3.4 Qq **Total Gate Charge** Q1 1.1 1.5 nC For Q1: Q2 V_{DS}=10 V, I_D= 0.7 A 1.4 2 V_{GS} = 4.5 V, R_{GEN} = 6 Ω 0.24 Q1 Q_{gs} Gate-Source Charge nC For **Q2**: 0.3 Q2 $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -0.6 \text{ A}$ Q_{ad} Gate-Drain Charge Q1 0.3 nC V_{GS} = -4.5 V, R_{GEN} = 6 Ω Q2 0.4

	cal Characteristics		T _A = 25°C unless otherwise noted					
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units		
Drain-S	ource Diode Characteris	tics a	nd Maximum Ratings					
ls	Maximum Continuous Drain-S	ource [Diode Forward Current	Q1			0.25	А
ls	Maximum Continuous Drain-S	ource [Diode Forward Current	Q1 Q2			0.25 0.25	A
Is V _{SD}	Maximum Continuous Drain–Source Diode Forward	ource [···· · · · · · · · · · · · · · · · · ·			0.74		A

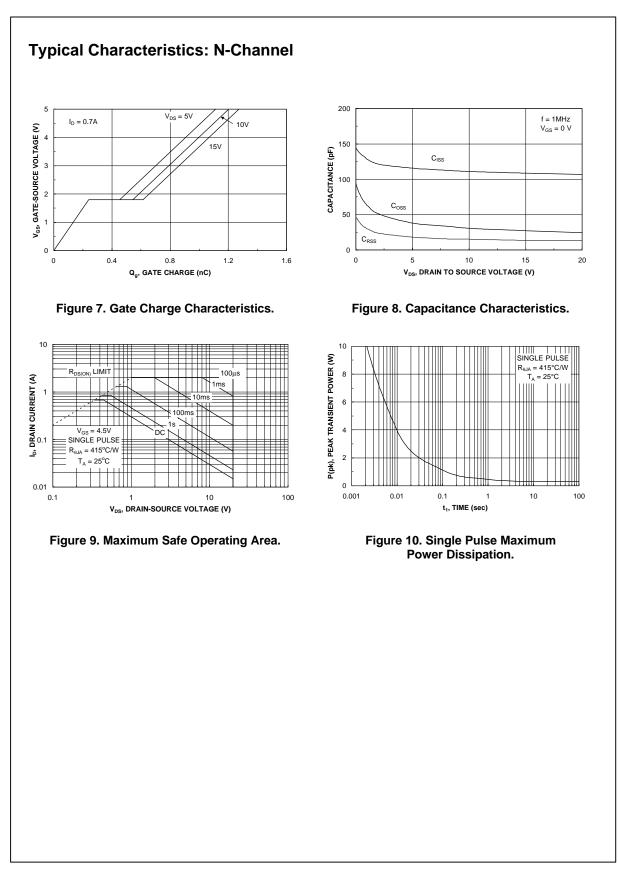
Notes:

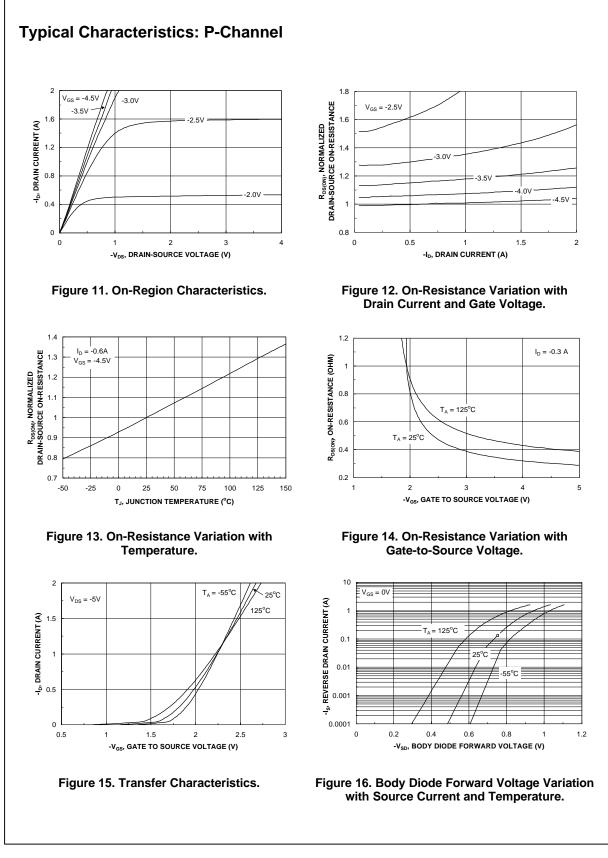
 R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8JA} is determined by the user's board design. R_{8JA} = 415°C/W when mounted on a minimum pad of FR-4 PCB in a still air environment.

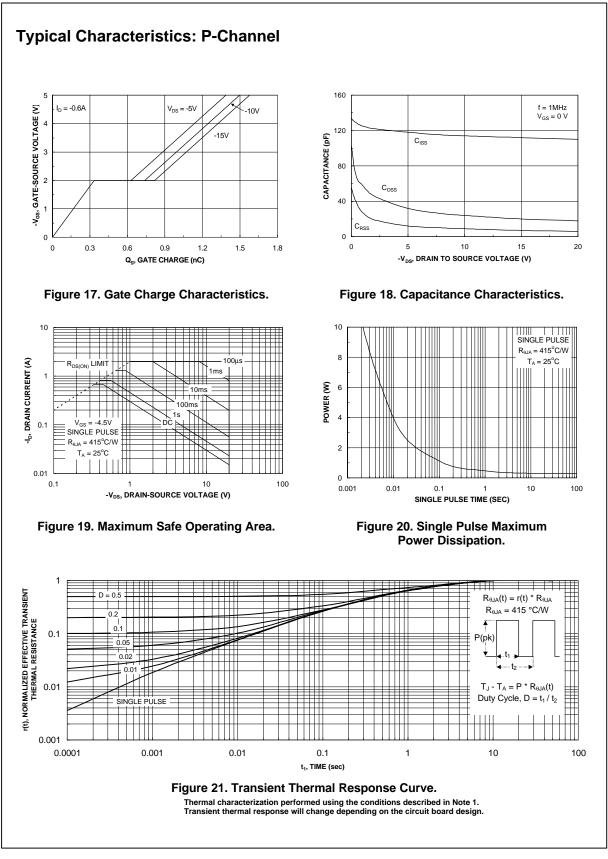
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%



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